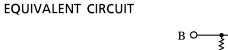
TOSHIBA RN5006

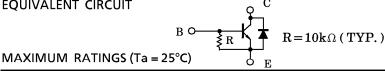
TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL TYPE (PCT PROCESS)

RN5006

MOTOR DRIVE CIRCUIT APPLICATIONS. POWER AMPLIFIER APPLICATIONS. POWER SWITCHING APPLICATIONS.

- With Built-in Bias Resistors
- Simplify Circuit Design
- Reduce a Quantity of Parts and Manufacturing Process
- Small Flat Package
- P_C=1~2W (Mounted on Ceramic substrate)
- Complementary to RN6006





CHARACTERISTIC		SYMBOL	RATING	UNIT	
Collector-Base Voltage		v_{CBO}	10	V	
Collector-Emitter Voltage		v_{CES}	10	V	
Emitter-Base Voltage		$ m v_{EBO}$	6	V	
Collector Current	DC	$I_{\mathbb{C}}$	2	A	
	Pulse (Note1)	I_{CP}	4		
Base Current		$I_{\mathbf{B}}$	0.4	Α	
Collector Power Dissipation		P _C 500		mW	
Collector Power Dissipation		$P_{\mathbf{C}^*}$	1000	mW	
Junction Temperature		$\mathrm{T_{j}}$	150	$^{\circ}\mathrm{C}$	
Storage Temperature Range		$\mathrm{T_{stg}}$	-55~150	°C	

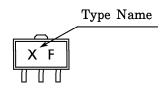
Note: Pulse Width ≤ 10 ms, Duty Cycle $\leq 30\%$ * : Mounted on ceramic substrate (250mm²×0.8t) ELECTRICAL CHARACTERISTICS (Ta = 25°C)

	Omit in inin					
4.6 MAX. 1.7 MAX. 0.45 - 0.05 1.5 ± 0.1	1,6MAX. 0.4±0.05 1.5±0.1 1.6MAX. 0.8WIII 1.008 0.4-0.05 1.5±0.1					
1. BASE 2. COLLECTO 3. EMITTER	R (HEAT SINK)					
PW-MINI						
JEDEC	_					
EIAJ	SC-62					
TOSHIBA 2	2-5K1A					

Unit in mm

Weight: 0.05g

MARKING



CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	I_{CBO}	$V_{CB} = 10V, I_{E} = 0$	I	_	0.1	μ A
Emitter Cut-off Current	I_{EBO}	$V_{EB}=6V, I_{C}=0$	0.462	0.60	0.857	mA
Collector-Emitter Breakdown Voltage	V _{(BR)CES}	I _C =1mA	10	_	_	V
DC Current Gain	$h_{\mathrm{FE}(1)}$	$V_{CE} = 1V, I_{C} = 0.5A$	160	_	600	
De current dam	$h_{\mathrm{FE}(2)}$	$V_{CE}=1V$, $I_{C}=4.0A$	60	_	_	
Collector-Emitter Saturation Voltage	V _{CE(sat)}	$I_{C}=2A, I_{B}=0.05A$	-	_	0.5	V
Transition Frequency	$ m f_{T}$	$V_{CE} = 1V, I_{C} = 0.5A$	-	140		MHz
Collector Output Capacitance	C_{ob}	$V_{CB} = 10V, I_E = 0, f = 1MHz$	-	30	_	pF
Resistor	R		7	10	13	kΩ

TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general am malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.

The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.

The information contained herein is subject to change without notice.